Surge arrester

3-electrode arrester

Series/Type: TG30-A90XSMD
Ordering code: B88069X9991T203
Date: 2019-07-23
Version: 06
Product description
The TG30 series has been especially designed to meet data line protection requirements. The optimized design features a high level of protection against fast rising transients usually caused by lightning disturbances. For use in high frequency data-lines, the series offers ultra low capacitances and shows only marginally signal losses up to high frequencies. The devices are extremely reliable and are able to withstand high surge currents without destruction.

Features
- Very small size
- Fast response time
- High current handling capability
- Stable performance over service life
- Ultra low capacitance and insertion loss
- High insulation resistance
- Excellent SMD handling
- RoHS-compatible

Applications
Telecommunication:
- Ethernet, PoE, xDSL
- Cable modem, splitters, line cards
- Wireless-antenna protection
Others:
- CCTV
- ESD protection

Product characteristics

<table>
<thead>
<tr>
<th>Physical dimensions (diameter × length)</th>
<th>Ø0.13 × 0.26</th>
<th>in</th>
</tr>
</thead>
<tbody>
<tr>
<td>Ø3.5 × 6.8</td>
<td>mm</td>
<td></td>
</tr>
<tr>
<td>Weight</td>
<td>~ 0.5</td>
<td>g</td>
</tr>
<tr>
<td>Operating temperature</td>
<td>−40 ... +125</td>
<td>°C</td>
</tr>
<tr>
<td>Recommended storage 1)</td>
<td>+5 ... +35</td>
<td>°C</td>
</tr>
<tr>
<td>- temperature</td>
<td>45 ... 80</td>
<td>°C</td>
</tr>
<tr>
<td>- humidity</td>
<td>≤ 2</td>
<td>%</td>
</tr>
<tr>
<td>- period</td>
<td>≤ 2</td>
<td>years</td>
</tr>
<tr>
<td>Climatic category (IEC 60068-1)</td>
<td>40/125/21</td>
<td></td>
</tr>
<tr>
<td>Moisture sensitivity level 2)</td>
<td>1</td>
<td></td>
</tr>
<tr>
<td>Marking</td>
<td>without</td>
<td></td>
</tr>
</tbody>
</table>

Notes:
1) Specified in terms of corrosion against Sn-plating
2) Tests according to JEDEC J-STD-020
### Electrical specifications and stress test methods

<table>
<thead>
<tr>
<th>Specification</th>
<th>Nominal DC spark-over voltage</th>
<th>Impulse spark-over voltage</th>
<th>Service life</th>
<th>Insulation resistance at 50 V&lt;sub&gt;DC&lt;/sub&gt;</th>
<th>Capacitance at 1 MHz</th>
<th>Arc voltage at 1 A</th>
<th>Glow to arc transition current</th>
<th>Glow voltage</th>
</tr>
</thead>
<tbody>
<tr>
<td>Min.</td>
<td>90 V</td>
<td>&lt; 450 V</td>
<td>2 A</td>
<td>&gt; 1 GΩ</td>
<td>&lt; 1.2 pF</td>
<td>~ 10 V</td>
<td>&lt; 0.5 A</td>
<td>~ 60 V</td>
</tr>
<tr>
<td>Max.</td>
<td>117 V</td>
<td>&lt; 550 V</td>
<td>100 A</td>
<td></td>
<td>&lt; 0.6 pF</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Tolerance</td>
<td>±30 %</td>
<td>&lt; 350 V</td>
<td>3 kA</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

#### Notes:
- **Nominal DC spark-over voltage**: 90 V (Min.) to 117 V (Max.)
- **Impulse spark-over voltage at 100 V/µs**: < 450 V (Min.) to < 550 V (Max.)
- **Impulse spark-over voltage at 1 kV/µs**: < 350 V (Min.) to < 550 V (Max.)
- **Service life**:
  - 10 operations at 50 Hz, 1 s: 2 A
  - 300 operations at 8/20 µs: 100 A
  - 10 operations at 8/20 µs: 3 kA
  - 300 operations at 5/320 µs: 150 A
  - 300 operations at 10/1000 µs: 20 A
- **Insulation resistance at 50 V<sub>DC</sub>**: > 1 GΩ
- **Capacitance at 1 MHz**: < 1.2 pF (< 0.6 pF)
- **Arc voltage at 1 A**: ~ 10 V
- **Glow to arc transition current**: < 0.5 A
- **Glow voltage**: ~ 60 V

---

3) At delivery AQL 0.65 level II, DIN ISO 2859
4) In ionized mode
5) Tip or ring electrode to center electrodes
6) Total current through center electrodes, half value through tip respectively, ring electrode.
7) Tip to ring electrode
8) Tip to center electrode additional ring to center electrode
9) Test generator 6 kV, 10/700 µs, 40 Ω
10) Electrical specifications may vary after stress tests
11) Tests according to ITU-T Rec. K. 12 and UL 497B

Terms and current waveforms in accordance with ITU-T Rec. K. 12; IEC 61643-21 and IEC 61643-311.
Surge arrester

B88069X9991T203

3-electrode arrester

TG30-A90XSMD

Dimensional drawing in mm

Ordering code and packing advice

B88069X9991T203 = SMD-tape with 2000 pcs.

SMD-tape according to IEC 60286-3
Soldering parameter

Reflow soldering

Surface mounted components (SMD) may exhibit a temporary increase in the DC spark-over voltage after the solder reflow process. The components will recover within 24 hours. There is no quality defect nor change in protection levels during the temporary change in DC spark-over voltage.

Cautions and warnings

- Do not operate surge arresters in power supply networks, whose maximum operating voltage exceeds the minimum spark-over voltage of the surge arresters.
- Surge arresters may become hot in the event of longer periods of current stress (burn risk). In the event of overload the connectors may fail or the component may be destroyed.
- Surge arresters must be handled with care and must not be dropped.
- Do not continue to use damaged surge arresters.
- The shown SMD pad dimensions represent a safe way to mount the arrester and are a recommendation of the manufacturer. During the reflow process it must be assured that no solder material reduces the insulation distance between the pads below the arrester.
- SMD surge arresters should be soldered within 24 month after shipment.

Display of ordering codes for TDK Electronics products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.tdk-electronics.tdk.com/orderingcodes.
The following applies to all products named in this publication:

1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.

2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.

3. The warnings, cautions and product-specific notes must be observed.

4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (www.tdk-electronics.tdk.com/material). Should you have any more detailed questions, please contact our sales offices.

5. We constantly strive to improve our products. Consequently, the products described in this publication may change from time to time. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also reserve the right to discontinue production and delivery of products. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

6. Unless otherwise agreed in individual contracts, all orders are subject to our General Terms and Conditions of Supply.

7. Our manufacturing sites serving the automotive business apply the IATF 16949 standard. The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements (“CSR”) TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that only requirements mutually agreed upon can and will be implemented in our Quality Management System. For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.
8. The trade names EPCOS, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, ExoCore, FilterCap, FormFit, LeaXield, MiniBlue, MiniCell, MKD, MKK, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, ThermoFuse, WindCap are trademarks registered or pending in Europe and in other countries. Further information will be found on the Internet at www.tdk-electronics.tdk.com/trademarks.